MBRAD8150H Taiwan Semiconductor

8A, 150V Schottky Barrier Surface Mount Rectifier

FEATURES

• AEC-Q101 gualified

TAIWAN

• Low power loss, high efficiency

IICONDUCTOR

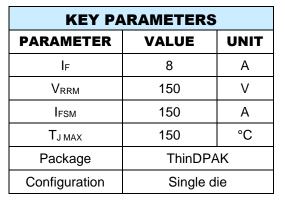
- Ideal for automated placement
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

- Low voltage, high frequency, inverter
- DC/DC converter
- Freewheeling diodes
- Reverse battery protection
- Car lighting

MECHANICAL DATA

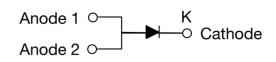
- Case: ThinDPAK
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.195g (approximately)







ThinDPAK



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	MBRAD8150H	UNIT
Marking code on the device			8150	
Repetitive peak reverse voltage		Vrrm	150	V
Reverse voltage, total rms value		V _{R(RMS)}	105	V
Forward current		lF	8	А
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms	1	150	А
	t = 1.0ms	IFSM	400	А
Junction temperature		TJ	-55 to +150	°C
Storage temperature		T _{STG}	-55 to +150	°C







THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance ⁽¹⁾	R _{ejl}	2.4	°C/W
Junction-to-ambient thermal resistance ⁽²⁾	Reja	12.6	°C/W
Junction-to-case thermal resistance ⁽²⁾	Rejc	3.3	°C/W

Notes:

1. With ideal heat sink

2. Units mounted on 2" x 3" x 0.25" Al-plate

ELECTRICAL SPECIFICATI	ONS (T _A = 25°C unless ot	herwise noted)			
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 4A, T_J = 25^{\circ}C$	VF	0.77	-	V
	$I_F = 8A, T_J = 25^{\circ}C$		0.84	0.95	V
	I _F = 4A, T _J = 125°C		0.63	-	V
	I _F = 8A, T _J = 125°C		0.71	0.80	V
Reverse current @ rated $V_R^{(2)}$	T _J = 25°C	1	-	10	μA
	T _J = 125°C	– I _R	-	2	mA
Junction capacitance	1MHz, V _R = 4.0V	CJ	155	-	pF

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
MBRAD8150H	ThinDPAK	4,500 / Tape & Reel



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

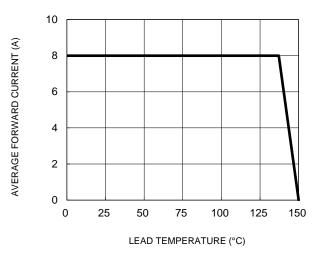
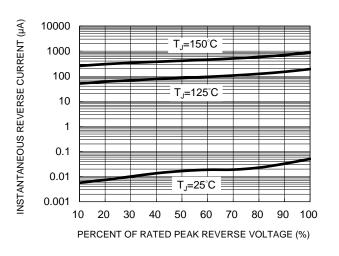


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics



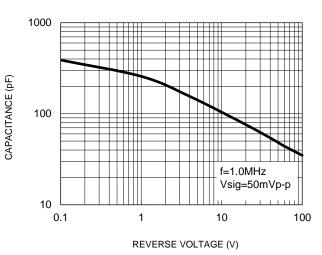
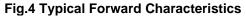
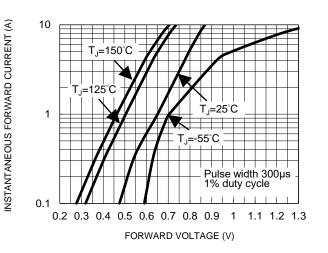


Fig.2 Typical Junction Capacitance





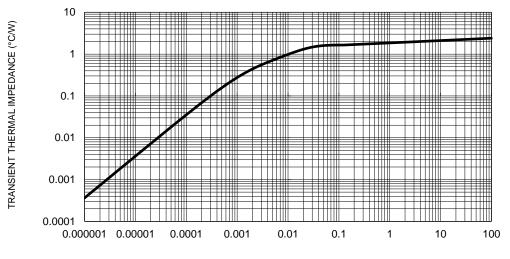
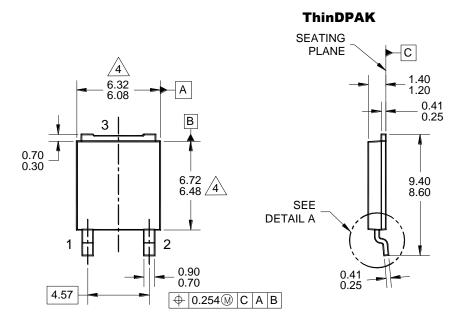


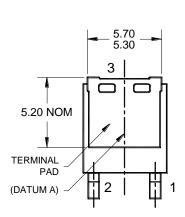
Fig.5 Typical Transient Thermal Impedance

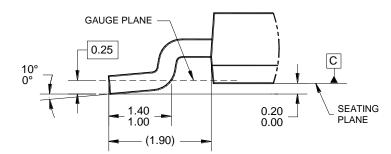
PULSE DURATION (s)



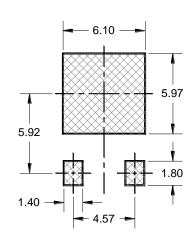
PACKAGE OUTLINE DIMENSIONS



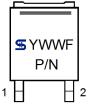




DETAIL A, ROTATED -90° (SCALE 4:1)



SUGGESTED PAD LAYOUT



MARKING DIAGRAM

YWW	= DATE CODE
F	= FACTORY CODE
P/N	= MARKING CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-252, VARIATION AE, ISSUE F.
- 4 MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION, OR GATE BURRS.
- 5. DWG NO. REF: HQ2SD07-TDPAK-065 REV A.



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